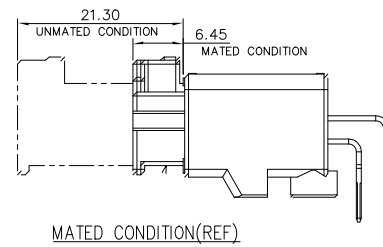
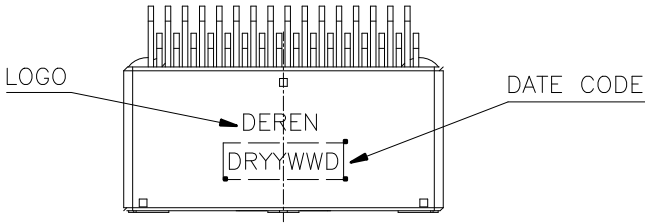
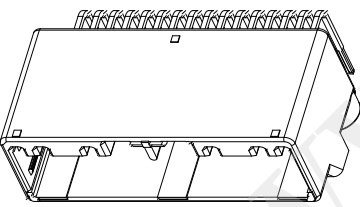
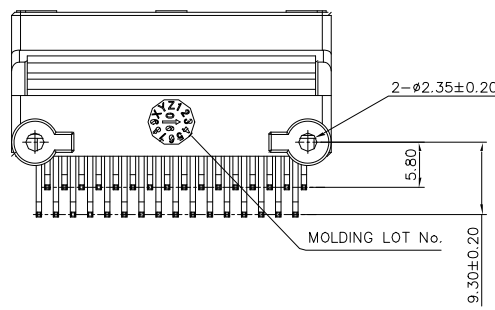
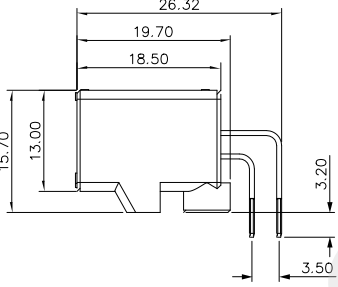
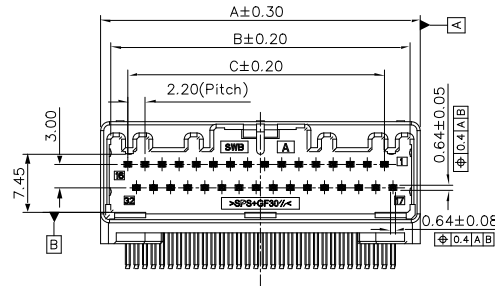


REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
1			INITIAL RELEASE	2023.03.14	Yy_D



- NOTES:
- PRODUCT MEETS CONTROLLED SUBSTANCES SPEC. ROHS 2.0
1. MATERIAL:
- 1.1 HOUSING: SPS, UL94V-0; COLOR: BLACK.
- 1.2 CONTACT: BRASS.
2. FINISH:
- 2.1 CONTACT: 100u"MIN. TIN PLATING ON SOLDER TAIL AREA.
- 50u". NICKEL UNDERPLATING OVERALL.
3. ELECTRICAL SPECIFICATION:
- 3.1 VOLTAGE RATING: 50V MAX. AC/DC.
- 3.2 CURRENT RATING: 3A MAX. AC/DC.
- 3.3 WITHSTANDING VOLTAGE: 1000V AC/MINUTE.
- 3.4 TEMPERATURE RANGE: -40°C~+125°C
- 3.5 INSULATION RESISTANCE: 1000MΩ.
- 3.6 CONTACT RESISTANCE: ≤5MΩ MAX.AFTER ENVIRONMENT TESTING:≤10MΩ



Poles	Dimensions (mm)		
	A	B	C
2*06	19.10	16.50	11.00
2*08	23.50	20.90	15.40
2*10	27.90	25.30	19.80
2*12	32.30	29.70	24.20
2*14	36.70	34.10	28.60
2*16	41.10	38.50	33.00
2*18	45.50	43.00	37.40
2*20	49.90	47.40	41.80

DIM	TOL	DIM	TOL
x.	±0.35	x.	±2'
.x	±0.30		
.xx	±0.25		

570CBG-033R*** **

CUSTOMER CODE

T: TRAY

G: TUBE

PIN:

12: 12PIN

.....

40: 40PIN

COLOR:

1: BLACK 2: NATURAL

3: GRAY

LOGO:

1: WITH LOGO

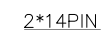
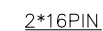
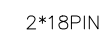
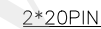
2: WITHOUT LOGO

R:RoHS

H:HALOGEN-FREE

WAFER

		DEREN SHENZHEN DEREN ELECTRONIC CO., LTD			
DRAW NO.		CUSTOMER DRAWING	DATE	TITLE: WAFER 2.20PH 13H R/A DIP CONN	
***		DESIGN:	Yy_D	2023.03.14	P/N:SEE TABLE
REV.		CHECK:			SHEET: 1/3
1		APPROVAL:			SCALE: 1:1 UNIT: mm



		DEREN SHENZHEN DEREN ELECTRONIC CO., LTD						
		CUSTOMER DRAWING		DATE		TITLE: WAFER 2.20PH 13H R/A DIP CONN		
DRAW NO.		DESIGN:		Yy_D	2023.03.14		P/N:SEE TABLE	
***		CHECK:					SHEET: 2/3 	
REV.	1	APPROVAL:					SCALE: 1:1	UNIT: mm

DEREN

SHENZHEN DEREN ELECTRONIC CO., LTD

CUSTOMER DRAWING	DATE
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DESIGN:	Yy_D	2023.03.14
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CHECK:		
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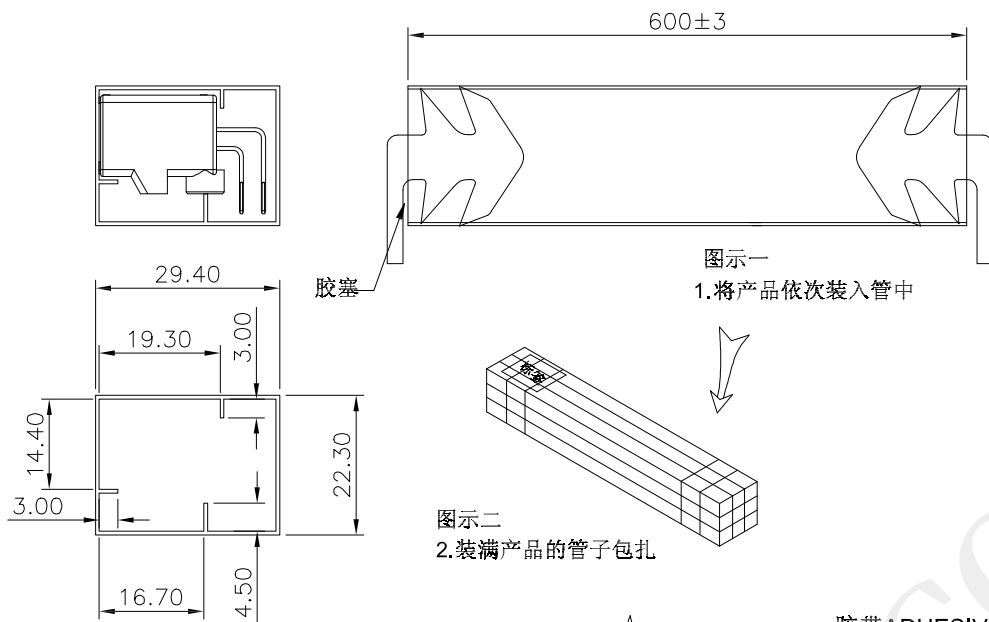
APPROVAL:		
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TITLE: WAFER 2.20PH 13H R/A DIP CONN

4	P/N:SEE TABLE
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SHEET:	2/3	
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SCALE:	1:1	UNIT:	mm
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说明:

- 1.将产品依图示方向放入真空管内，方向须一致，每个真空管放的产品数量依Pin数不同而不同，具体详见包装明细表，真空管两头用胶塞塞住，如图示一。
- 2.将装好产品的真空管平放在桌面上以3PCS为一排然后叠放3列或2列为1把如图二或图三，整理好后用PE膜将1把真空管两头PE膜缠绕包好，并在左边PE膜处贴1PCS产品标签，如图示二。
- 3.将上步完成的产品以每把进行包扎，包装成一整扎，以图示三
- 4.将包扎好产品放入纸箱内，并将纸箱用胶带封好，在其侧面右上角贴上出货标签。
- 5.纸箱规格：600*200*180mm 真空管规格：600*29.4*22.3mm
- 6.纸箱厚度：6~7mm

图示二

2.装满产品的管子包扎

图示三

3.将每扎管子包扎

胶带ADHESIVE
TAPE

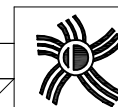
标签LABEL

图示四

4.装箱，封胶

PIN数	每支真空产品 数量PCS/管	每箱真空管数量 PCS管/箱	每箱包装数量 PCS/箱
2*06	30	48	1440
2*08	24	48	1152
2*10	20	48	960
2*12	17	48	816
2*14	15	48	720
2*16	13	48	624
2*18	12	48	576
2*20	11	48	528

DIM	TOL	DIM	TOL
x.		x.	
.x			
.xx			



DEREN

SHENZHEN DEREN ELECTRONIC CO., LTD

DRAW NO.

REV.

1

CUSTOMER DRAWING

DESIGN:

Yy_D

CHECK:

APPROVAL:

DATE

2023.03.14

TITLE: WAFER 2:20PH 13H

P/N:SEE TABLE

SHEET: 3/3

SCALE: N/A UNIT: mm